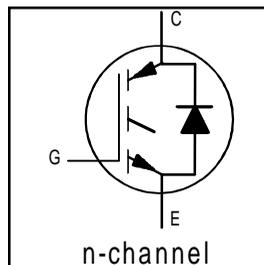


## INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

UltraFast CoPack IGBT

### Features

- 2.5kV, 60s insulation voltage ⑤
- 4.8 mm creepage distance to heatsink
- UltraFast: Optimized for high operating frequencies 8-40 kHz in hard switching, >200 kHz in resonant mode
- IGBT co-packaged with HEXFRED™ ultrafast, ultrasoft recovery antiparallel diodes
- Tighter parameter distribution
- Industry standard Isolated TO-220 Fullpak™ outline



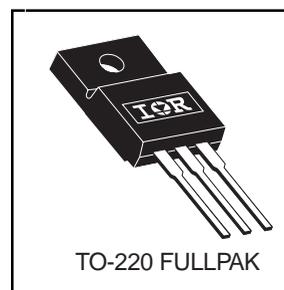
$$V_{CES} = 600V$$

$$V_{CE(on) \text{ typ.}} = 1.95V$$

$$@V_{GE} = 15V, I_C = 12A$$

### Benefits

- Simplified assembly
- Highest efficiency and power density
- HEXFRED™ antiparallel Diode minimizes switching losses and EMI



TO-220 FULLPAK

### Absolute Maximum Ratings

|                                 | Parameter                                | Max.                              | Units |
|---------------------------------|--|-----------------------------------|-------|
| $V_{CES}$                       | Collector-to-Emitter Voltage             | 600                               | V     |
| $I_C @ T_C = 25^\circ\text{C}$  | Continuous Collector Current             | 17                                | A     |
| $I_C @ T_C = 100^\circ\text{C}$ | Continuous Collector Current             | 8.9                               |       |
| $I_{CM}$                        | Pulsed Collector Current ①               | 92                                |       |
| $I_{LM}$                        | Clamped Inductive Load Current ②         | 92                                |       |
| $I_F @ T_C = 100^\circ\text{C}$ | Diode Continuous Forward Current         | 8.5                               |       |
| $I_{FM}$                        | Diode Maximum Forward Current            | 92                                |       |
| $Visol$                         | RMS Isolation Voltage, Terminal to Case⑤ | 2500                              | V     |
| $V_{GE}$                        | Gate-to-Emitter Voltage                  | $\pm 20$                          |       |
| $P_D @ T_C = 25^\circ\text{C}$  | Maximum Power Dissipation                | 45                                | W     |
| $P_D @ T_C = 100^\circ\text{C}$ | Maximum Power Dissipation                | 18                                |       |
| $T_J$                           | Operating Junction and                   | -55 to +150                       | °C    |
| $T_{STG}$                       | Storage Temperature Range                |                                   |       |
|                                 | Soldering Temperature, for 10 sec.       | 300 (0.063 in. (1.6mm) from case) |       |
|                                 | Mounting Torque, 6-32 or M3 Screw.       | 10 lbf•in (1.1 N•m)               |       |

### Thermal Resistance

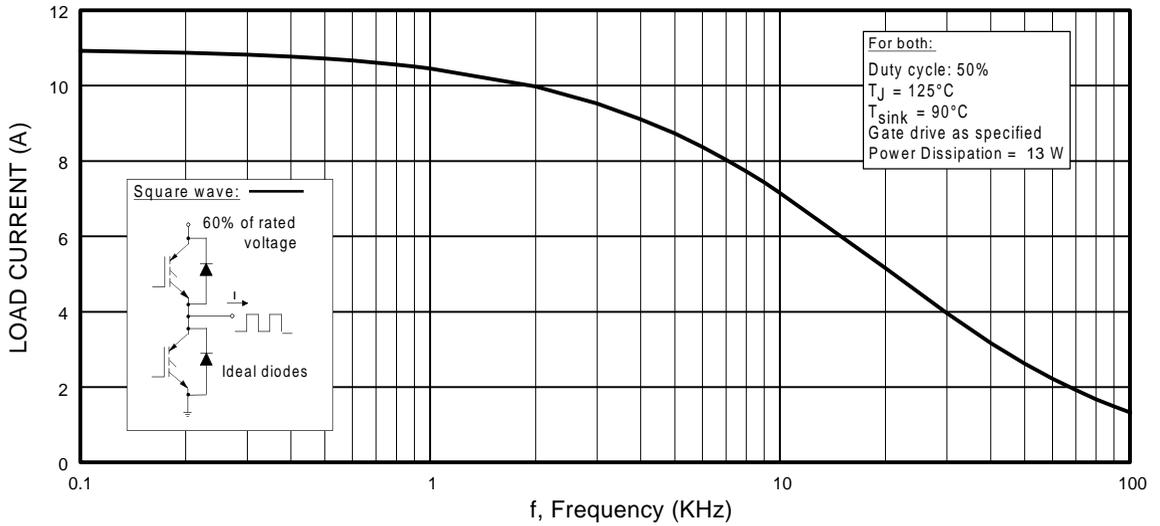
|                 | Parameter                                 | Typ.       | Max. | Units  |
|-----------------|---|------------|------|--------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | —          | 2.8  | °C/W   |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | —          | 4.1  |        |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —          | 65   |        |
| Wt              | Weight                                    | 2.0 (0.07) | —    | g (oz) |

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

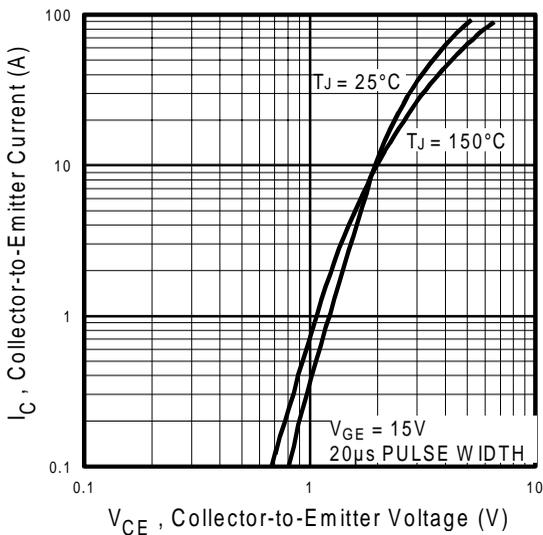
|                                 | Parameter   | Min. | Typ. | Max.      | Units                | Conditions  |
|---------------------------------|---|------|------|-----------|----------------------|---|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage <sup>f</sup> | 600  | —    | —         | V                    | $V_{GE} = 0V, I_C = 250\mu A$                         |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage             | —    | 0.63 | —         | V/ $^\circ\text{C}$  | $V_{GE} = 0V, I_C = 1.0mA$                            |
| $V_{CE(on)}$                    | Collector-to-Emitter Saturation Voltage             | —    | 1.95 | 2.1       | V                    | $I_C = 12A$ $V_{GE} = 15V$                            |
|                                 |   | —    | 2.52 | —         |                      | $I_C = 23A$ See Fig. 2, 5                             |
|                                 |   | —    | 2.09 | —         |                      | $I_C = 12A, T_J = 150^\circ\text{C}$                  |
| $V_{GE(th)}$                    | Gate Threshold Voltage                              | 3.0  | —    | 6.0       |                      | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage             | —    | -11  | —         | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $g_{fe}$                        | Forward Transconductance <sup>④</sup>               | 3.1  | 8.6  | —         | S                    | $V_{CE} = 100V, I_C = 12A$                            |
| $I_{CES}$                       | Zero Gate Voltage Collector Current                 | —    | —    | 250       | $\mu A$              | $V_{GE} = 0V, V_{CE} = 600V$                          |
|                                 |   | —    | —    | 2500      |                      | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
| $V_{FM}$                        | Diode Forward Voltage Drop                          | —    | 1.4  | 1.7       | V                    | $I_C = 12A$ See Fig. 13                               |
|                                 |   | —    | 1.3  | 1.6       |                      | $I_C = 12A, T_J = 150^\circ\text{C}$                  |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current                     | —    | —    | $\pm 100$ | nA                   | $V_{GE} = \pm 20V$                                    |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

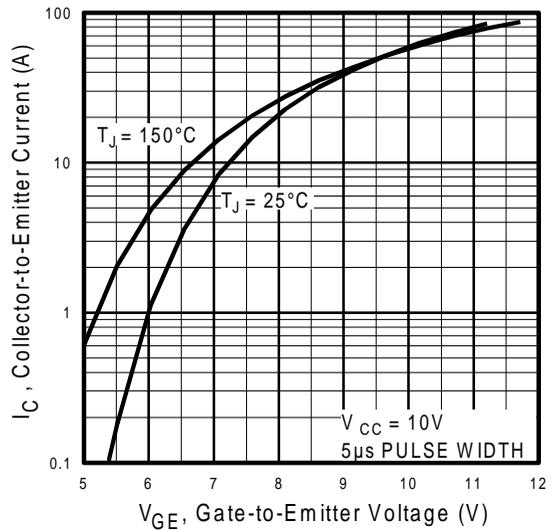
|                  | Parameter  | Min. | Typ. | Max. | Units  | Conditions   |  |
|------------------|--|------|------|------|--|--|--|
| $Q_g$            | Total Gate Charge (turn-on)                      | —    | 50   | 75   | nC   | $I_C = 12A$  |  |
| $Q_{ge}$         | Gate - Emitter Charge (turn-on)                  | —    | 8.1  | 12   |  | $V_{CC} = 400V$ See Fig. 8                               |  |
| $Q_{gc}$         | Gate - Collector Charge (turn-on)                | —    | 18   | 27   |  | $V_{GE} = 15V$   |  |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 40   | —    | ns   | $T_J = 25^\circ\text{C}$                                 |  |
| $t_r$            | Rise Time  | —    | 21   | —    |  | $I_C = 12A, V_{CC} = 480V$                               |  |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 91   | 140  |  | $V_{GE} = 15V, R_G = 23\Omega$                           |  |
| $t_f$            | Fall Time  | —    | 80   | 130  |  | Energy losses include "tail" and diode reverse recovery. |  |
| $E_{on}$         | Turn-On Switching Loss                           | —    | 0.38 | —    |  | mJ   | See Fig. 9, 10, 11, 18                             |
| $E_{off}$        | Turn-Off Switching Loss                          | —    | 0.16 | —    |  |  |  |
| $E_{ts}$         | Total Switching Loss                             | —    | 0.54 | 0.9  |  |  |  |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 40   | —    |  | ns   | $T_J = 150^\circ\text{C}$ , See Fig. 9, 10, 11, 18 |
| $t_r$            | Rise Time  | —    | 22   | —    |  |  | $I_C = 12A, V_{CC} = 480V$                         |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 120  | —    |  |  | $V_{GE} = 15V, R_G = 23\Omega$                     |
| $t_f$            | Fall Time  | —    | 180  | —    | Energy losses include "tail" and diode reverse recovery. |  |  |
| $E_{ts}$         | Total Switching Loss                             | —    | 0.89 | —    | mJ   |  |  |
| $L_E$            | Internal Emitter Inductance                      | —    | 7.5  | —    | nH   | Measured 5mm from package                                |  |
| $C_{ies}$        | Input Capacitance                                | —    | 1100 | —    | pF   | $V_{GE} = 0V$  |  |
| $C_{oes}$        | Output Capacitance                               | —    | 73   | —    |  | $V_{CC} = 30V$ See Fig. 7                                |  |
| $C_{res}$        | Reverse Transfer Capacitance                     | —    | 14   | —    |  | $f = 1.0MHz$   |  |
| $t_{rr}$         | Diode Reverse Recovery Time                      | —    | 42   | 60   | ns   | $T_J = 25^\circ\text{C}$ See Fig. 14                     |  |
|                  |  | —    | 80   | 120  |  | $T_J = 125^\circ\text{C}$                                |  |
| $I_{rr}$         | Diode Peak Reverse Recovery Current              | —    | 3.5  | 6.0  | A  | $T_J = 25^\circ\text{C}$ See Fig. 15                     |  |
|                  |  | —    | 5.6  | 10   |  | $T_J = 125^\circ\text{C}$                                |  |
| $Q_{rr}$         | Diode Reverse Recovery Charge                    | —    | 80   | 180  | nC   | $T_J = 25^\circ\text{C}$ See Fig. 16                     |  |
|                  |  | —    | 220  | 600  |  | $T_J = 125^\circ\text{C}$                                |  |
| $di_{(rec)M}/dt$ | Diode Peak Rate of Fall of Recovery During $t_b$ | —    | 180  | —    | A/ $\mu s$   | $T_J = 25^\circ\text{C}$ See Fig. 17                     |  |
|                  |  | —    | 120  | —    |  | $T_J = 125^\circ\text{C}$                                |  |



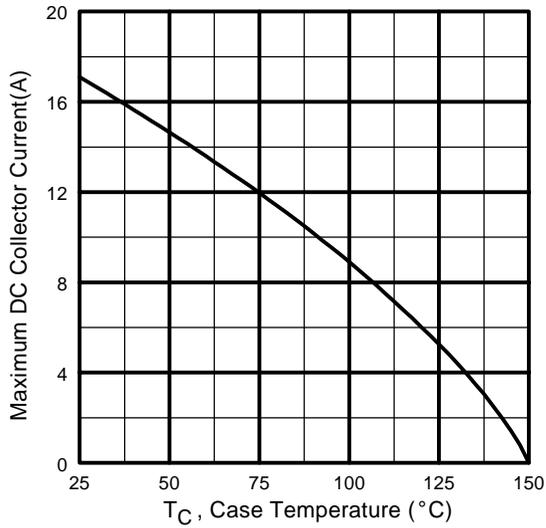
**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{\text{RMS}}$  of fundamental)



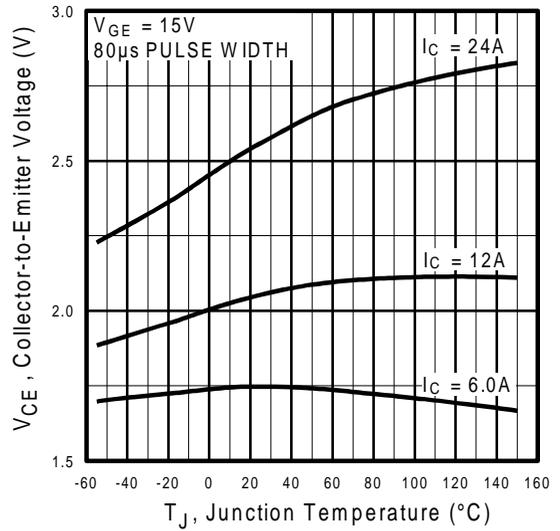
**Fig. 2 - Typical Output Characteristics**



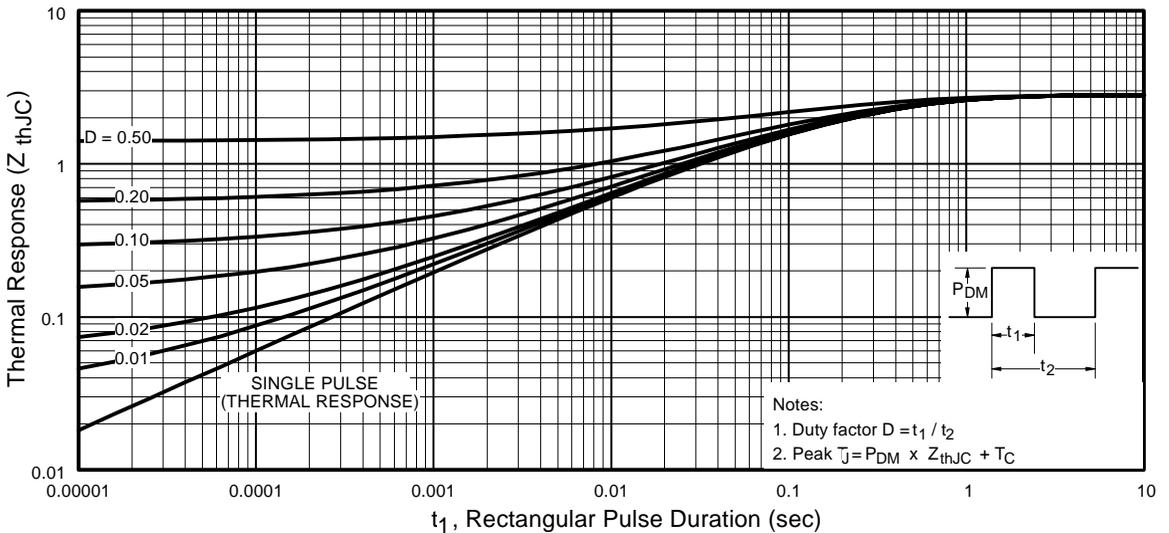
**Fig. 3 - Typical Transfer Characteristics**



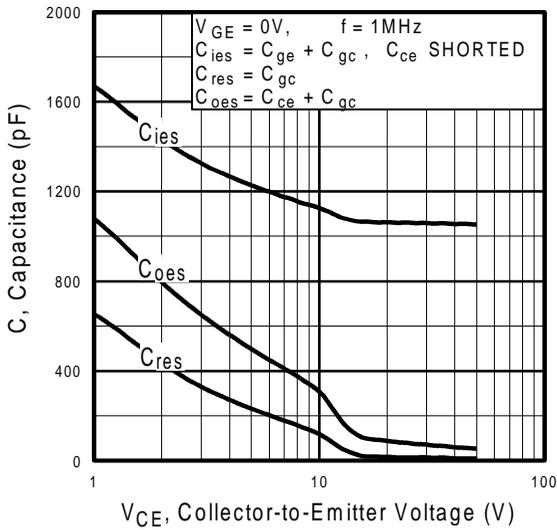
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



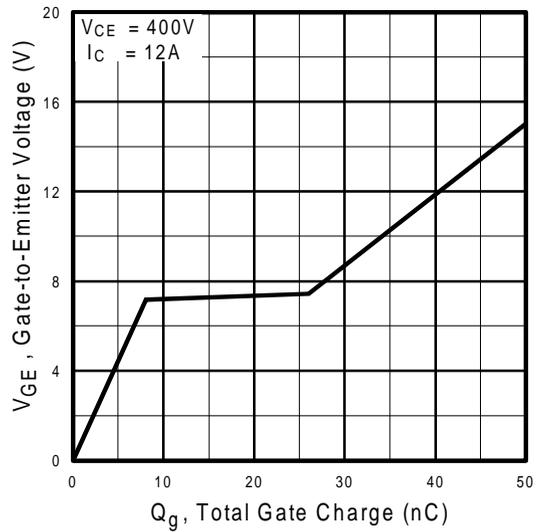
**Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature**



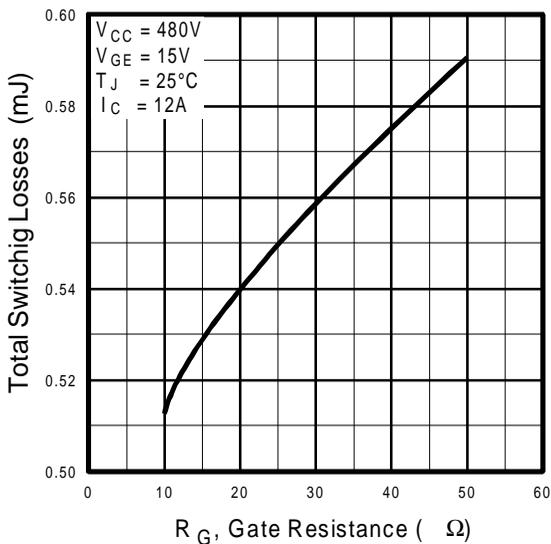
**Fig. 6 - Maximum IGBT Effective Transient Thermal Impedance, Junction-to-Case**



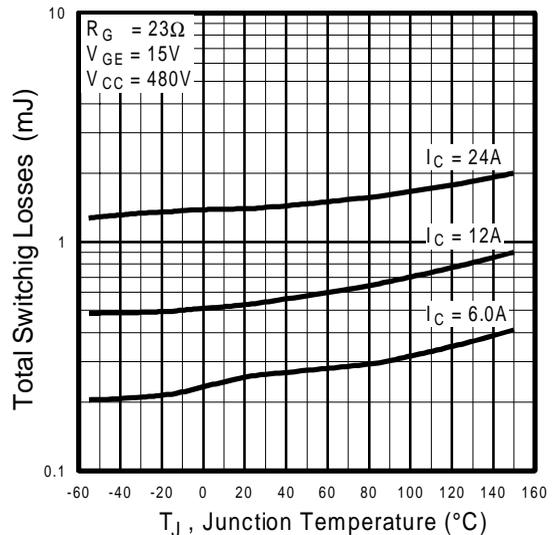
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage

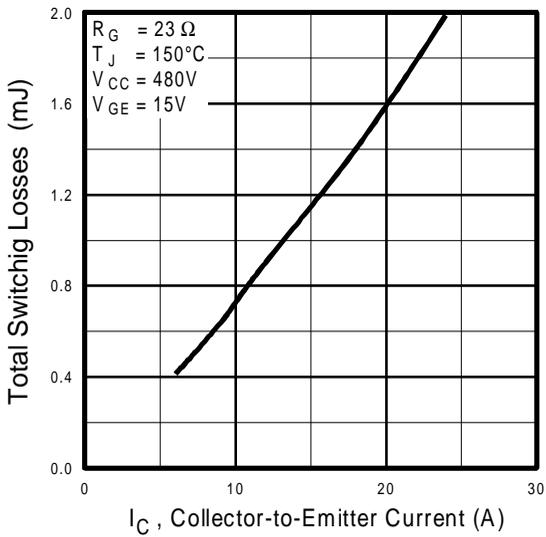


**Fig. 9** - Typical Switching Losses vs. Gate Resistance

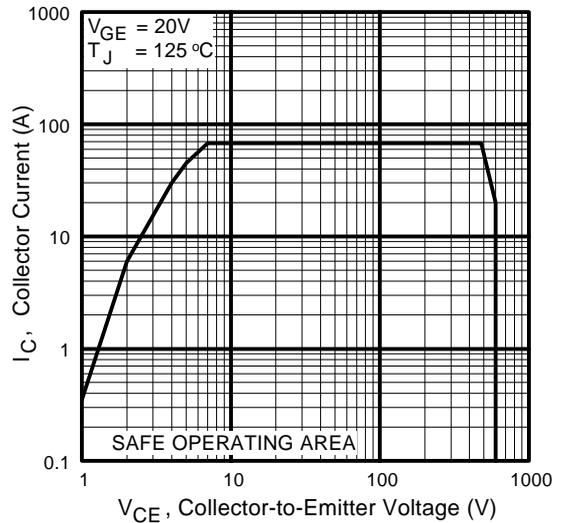


**Fig. 10** - Typical Switching Losses vs. Junction Temperature

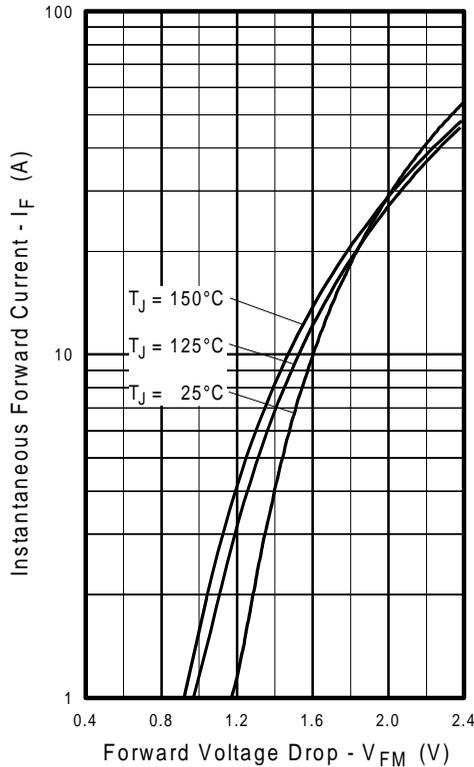
# IRG4IBC30UD



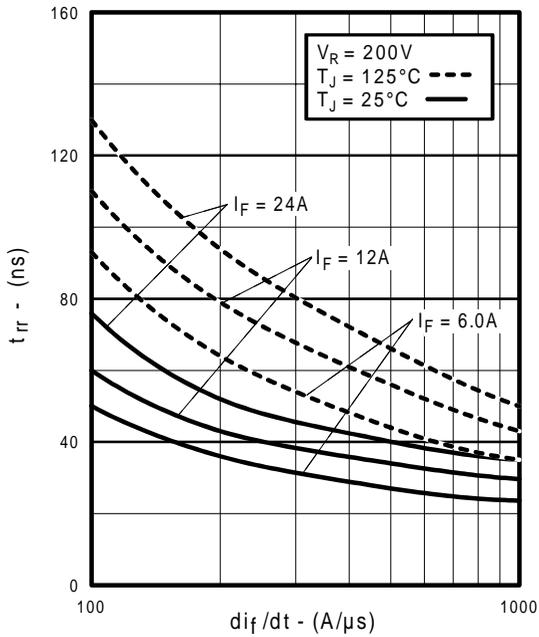
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



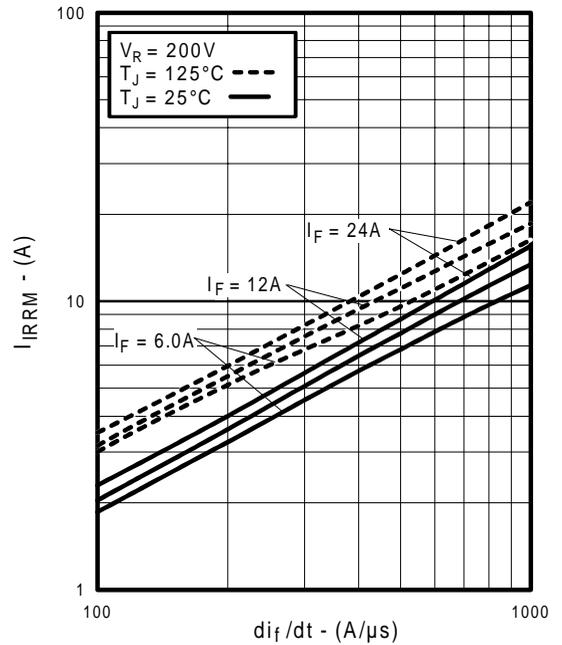
**Fig. 12** - Turn-Off SOA



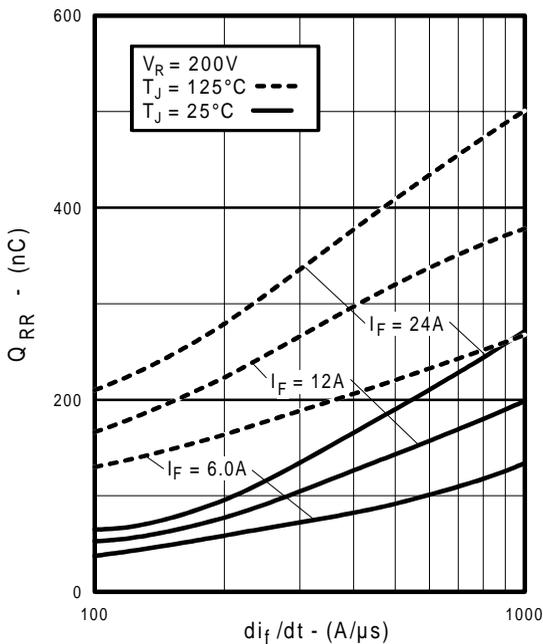
**Fig. 13** - Maximum Forward Voltage Drop vs. Instantaneous Forward Current



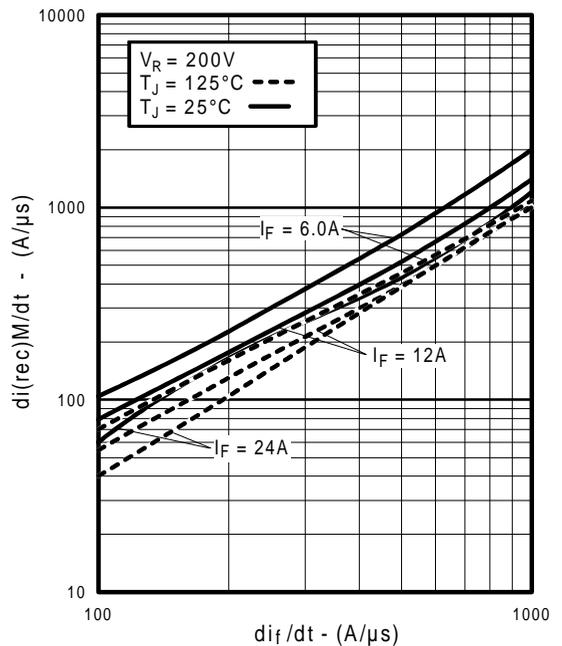
**Fig. 14** - Typical Reverse Recovery vs.  $di_f/dt$



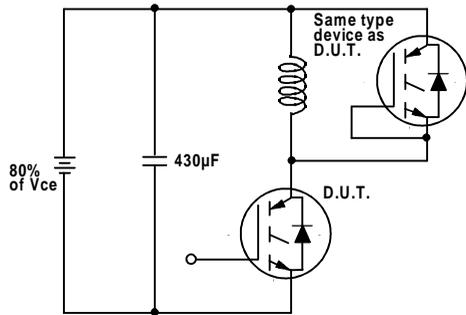
**Fig. 15** - Typical Recovery Current vs.  $di_f/dt$



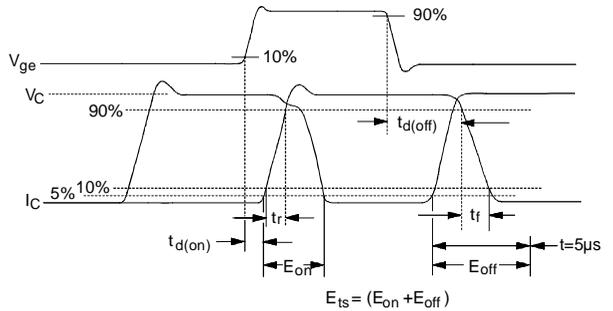
**Fig. 16** - Typical Stored Charge vs.  $di_f/dt$



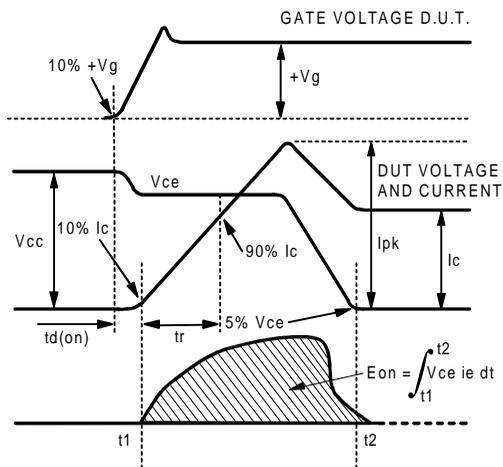
**Fig. 17** - Typical  $di_{(rec)M}/dt$  vs.  $di_f/dt$



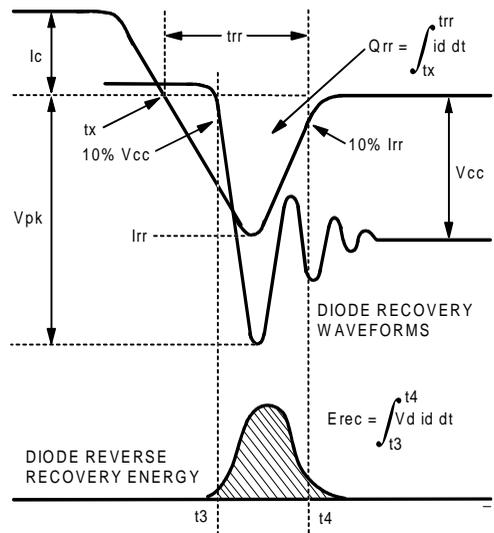
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

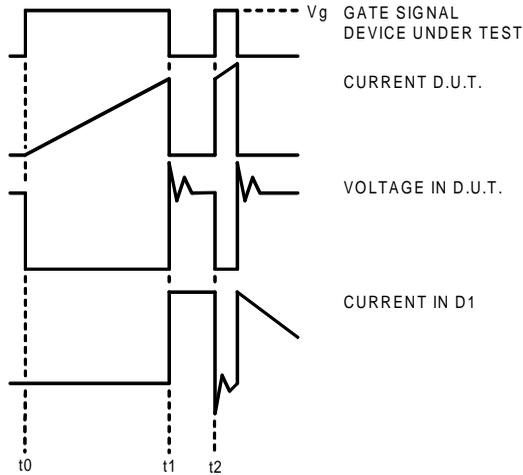


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

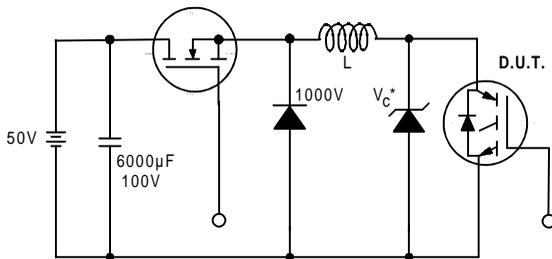


Figure 19. Clamped Inductive Load Test Circuit

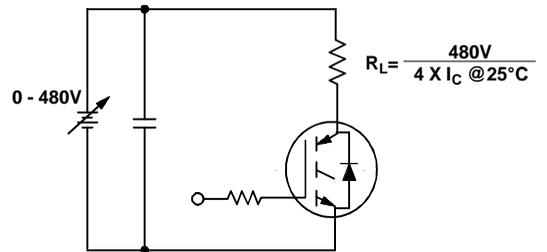


Figure 20. Pulsed Collector Current Test Circuit

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## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\% (V_{CES})$ ,  $V_{GE}=20V$ ,  $I_L=10\mu H$ ,  $R_G = 23\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.
- ⑤  $t = 60s$ ,  $f = 60Hz$

## Case Outline — TO-220 FULLPAK

